FUĴĨTSU

930 Series 32-BIT RISC EMBEDDED PROCESSOR

May 25, 1994

FEATURES

- 40 MHz (25ns/cycle) operating frequency
- SPARC® high-performance RISC architecture
- 2 Kbytes 2-way set associative instruction cache
- 2 Kbytes 2-way set associative data cache
- Flexible locking mechanism for data and instruction cache entries
- Harvard-style separate instruction and data buses on-chip
- 8 window, 136 word register file
- Fast interrupt response time
- 247 address spaces, 4 Gbyte each
- User and supervisor modes
- Buffered writes and instruction pre-fetching
- Fast page-mode DRAM support
- Programmable address decoder and wait-state generator
- 16-bit auto reload timer
- On-chip clock generator circuit
- JTAG test interface
- Emulator support hardware
- Single vector trapping
- 0.8 micron gate, 3 level metal CMOS technology

GENERAL DESCRIPTION

The MB86930 is a member of the 930 series of RISC processors which offers high performance and high integration for a wide range of embedded applications. The processor is based on the SPARC architecture and is upward code compatible with previous implementations. At 40 MHz, the processor executes with 40 MIPs peak and 37 MIPs sustained performance.

On-chip data and instruction caches are included to help decouple the processor from external memory latency. Separate on-chip instruction and data paths provide a high bandwidth interface between the IU and caches. Included to maximize the performance of the system with minimum glue logic, are chip select outputs, programmable wait-state generation and built-in support for a high performance connection to page-mode DRAM. See MB86930 block diagram on page 5.

Support for debug and diagnostic tools has been included on-chip and allows for direct connection to hardware emulators and improves debug capability when using ROM based monitors.

These features combine to give the MB86930 superior speed, flexibility and efficiency to make it the ideal choice for a wide variety of low-cost, high-performance embedded systems.

PIN CONFIGURATION





PIN ASSIGNMENT — 179-PIN PGA

PIN NO.	PIN NAME	TYPE	PIN NO.	PIN NAME	TYPE	PIN NO.	PIN NAME	TYPE	PIN NO.	PIN NAME	TYPE
1	VDD	_	46	ADR < 19 >	0	91	IRL < 2 >	1	136	VSS	_
2	ASI < 0 >	0	47	ADR < 18 >	0	92	ADR < 31 >	0	137	ADR < 24 >	0
3	–BE < 2 >	0	48	ADR < 16 >	0	93	ADR < 29 >	0	138	VDD	_
4	-SAME_PAGE	0	49	ADR < 15 >	0	94	VDD	_	139	VSS	_
5	–CS < 5 >	0	50	ADR < 13 >	0	95	ADR < 23 >	0	140	VDD	_
6	-CS < 2 >	0	51	ADR < 12 >	0	96	ADR < 21 >	0	141	ADR < 10 >	0
7	–CS < 1 >	0	52	VSS	—	97	ADR < 20 >	0	142	ADR < 8 >	0
8	–AS	0	53	ADR < 7 >	0	98	ADR < 17 >	0	143	VDD	_
9	RD/–WR	0	54	ADR < 5 >	0	99	ADR < 14 >	0	144	ASI < 7 >	0
10	-BGRNT	0	55	ADR < 3 >	0	100	ADR < 11 >	0	145	VDD	_
11	-READY	I.	56	ASI < 5 >	0	101	ADR < 9 >	0	146	VSS	—
12	-RESET	I	57	ASI < 4 >	0	102	ADR < 6 >	0	147	VSS	—
13	D < 0 >	I/O	58	ASI < 1 >	0	103	ADR < 4 >	0	148	VDD	_
14	VDD	_	59	–BE < 1 >	0	104	ASI < 6 >	0	149	VSS	_
15	VSS	_	60	VDD	—	105	ASI < 3 >	0	150	VDD	_
16	VDD		61	VSS	_	106	ASI < 2 >	0	151	VSS	
17	D < 10 >	I/O	62	-CS < 3 >	0	107	-BE < 0 >	0	152	D < 1 >	I/O
18	D < 14 >	1/0	63	-CS < 0 >	0	108	-BE < 3 >	0	153	D < 4 >	I/O
19	D < 15 >	I/O	64	-LOCK	0	109	-CS < 4 >	0	154	VSS	_
20	D < 16 >	1/0	65	VDD	_	110	VSS	_	155	VSS	_
21	D < 17 >	1/0	66	-MEXC	I	111	-ERROR	0	156	VDD	_
22	D < 20 >	1/0	67	VDD		112	VSS	<u> </u>	157	VSS	_
23	D < 21 >	I/O	68	D < 3 >	1/0	113	-BREQ	I	158	VDD	_
24	VDD	_	69	VSS	_	114	D<2>	1/0	159	VSS	_
25	D < 25 >	1/0	70	VDD		115	D<6>	1/0	160	D < 30 >	1/0
20	D < 28 >	1/0	71	D<9>	1/0	116	D < 7 >	1/0	161	EMU_D<0>	1/0
27	D < 29 >	1/0	72	D < 12 >	1/0	117	D < 6 >	1/0	162	V35 V66	_
20		_	73		1/0	110		1/0	164		_
29			74			120	V33 D = 19 5		165	VSS	
31		1/0	75	D < 10 >	1/0	120	D < 13 >	1/0	166	V33 VDD	
32	VSS	_	70	VSS		121	D < 23 >	1/0	167	VSS	_
33	CLKOUT2	0	78	D < 26 >	1/0	123	D < 27 >	1/0	168	VOO	_
34	XTAL 1	Ĩ	79	VDD		124	D < 31 >	1/0	169	ADR < 28 >	0
35	XTAL2	Ó	80	VDD	_	125	EMU D<2>	1/0	170	VSS	_
36	-TIMER OVE	õ	81	-EMU ENB	1	126	EMU $D < 3 >$	1/O	171	VSS	_
37	TDO	Ō	82	EMU SD < 0 >	I/O	127	EMU SD < 2 >	I/O	172	VDD	_
38	-TMS	1	83	EMU SD < 3 >	I/O	128	-EMU BRK	1	173	VSS	_
39	TDI	Ì	84	VSS	_	129	CLKOUT1	Ó	174	VDD	_
40	IRL < 1 >	1	85	VDD	_	130	VDD	_	175	VSS	_
41	IRL < 3 >	I.	86	VSS	_	131	VSS	_	176	ADR < 2 >	0
42	ADR < 30 >	0	87	VDD	_	132	-TRST	I	177	D < 5 >	I/O
43	VDD		88	VDD	_	133	IRL < 0 >	I	178	EMU_D < 1 >	I/O
44	ADR < 25 >	0	89	тск	1	134	VSS	_	179		0
45	ADR < 22 >	0	90	CLK_ECB	1	135	ADR < 26 >	0			
L			I	_		1			I		

ORDERING CODE

Clock Frequency (MHz)	Ordering Code	Pa	ckage Type	Marking on Part	P/N on Box
20	MB86930-20PFV-G	Plastic	QFP 208	MB86930-20	MB86930-20PFV-G-BND
30	MB86930-30ZF-G	Ceramic	QFP 208	MB86930-30	MB86930-30ZF-G-BND
40	MB86930-40ZF-G	Ceramic	QFP 208 w/FIN	MB86930-40	MB86930-40ZF-G-BND-FIN
40	MB86930-40CR-G	Ceramic	PGA 179	MB86930-40	MB86930-40CR-G-BND

Note: The ordering code is for production level product. Early shipments of this device may be marked with "ES" to indicate that the part is not yet at full production status. Contact your local Fujitsu representative for additional information on "ES" level products.



NO. PIN NAME TYPE NO. PIN NAME TYPE NO. PIN NAME TYPE NO. PIN NAME TYPE 1 ADR < 28 > 0 53 EMU D < 0.> 106 VSA 106 VSA 107 VDD - 159 ASI < 4.> 0 3 ADR < 30.> 0 55 -EMU LENB 1 107 VDD - 159 ASI < 4.> 0 6 VSS - 56 D < 31.> 100 110 D < 1.> 100 164 ASI < 5.> 0 7 VDD - 59 D < 30.> 100 111 D < 0.> 116 ABI < 4.> 0 8 IRL < 3. 1 61 VDD - 113 -REC 1 166 ADR < 4.> 0 10 IRL < 4.> 1 61 D < 27.> 100 114 -REC 1 168 VSS - 116 MSI < 4.>	PIN			PIN			PIN			PIN					
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	NO.	PIN NAME	TYPE	NO.	PIN NAME	TYPE	NO.	PIN NAME	TYPE	NO.	PIN NAME	TYPE			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	1	ADR < 28 >	0	53	EMU_D < 0 >	I/O	105	D < 4 >	I/O	157	VDD	_			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	2	ADR < 29 >	0	54	vss	_	106	VSS	_	158	N.C.	_			
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	3	ADR < 30 >	Ô	55	-FMU FNB	1	107	VDD	_	159	ASI < 4 >	0			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	4	ADR < 31 >	õ	56	VSS		108	D<3>	1/0	160	ASI<5>	õ			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	5		U	57			100	D < 2 >	1/0	161	ASI < 6 >	0			
0 0	5	VES	_	57		-	110		1/0	162	ASICOS	0			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	0	V 3 3	_	50	D<31>	1/0	110		1/0	102	ADD	0			
8 IRL<23> 1 60 D<23> 100 112 VDD 113 -RESET 1 165 ADR<43> 0 10 IRL<2> 1 63 D<22> 1/0 114 -RESET 1 165 ADR<45> 0 12 VSS - 64 VSS - 116 -MEXC 1 168 VSS - 13 CLK_ECB 1 65 D<225> 1/0 117 -READY 0 199 ADR<6> 0 14 TDI 1 66 D<225> 1/0 119 VDD - 171 N.C. - 16 TCK 1 68 VSS - 120 -BGRNT 172 ADR<8> 0 17 TMS 1 69 VDD - 122 -ERROR 174 VSS - 19 VSS - 71 VDD -	/		_	59	D < 30 >	1/0	111	D < 0 >	1/0	163	ADR < 2 >	0			
9 IRL<2> 1 61 VDD — 113 -RESEI I 165 ADR<4>> O 10 IRL<1> 1 62 Q22> 1/0 115 VSS — 166 ADR<4>> O 12 VSS — 64 VSS — 116 -MEXC 1 168 ADR<4>> O 14 TDI 1 66 D<22> 1/0 118 VSS — 169 ADR<7> O 15 -TRST 1 67 D<24> 1/0 119 VDD — 171 NC. — 16 TKK 1 68 VDD — 122 -ERROR 0 174 VSS — 19 VSS — 71 VDD — 122 -ERROR 0 177 N.C. — 20 VSS — 75 D<22> 1/0 125 RD/-WR	8	IRL < 3 >		60	D < 29 >	1/0	112	VDD	_	164	ADR < 3 >	0			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	9	IRL < 2 >	1	61	VDD		113	-RESET	1	165	ADR < 4 >	0			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	10	IRL < 1 >	I	62	D < 28 >	I/O	114	-BREQ	I	166	ADR < 5 >	0			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	11	IRL < 0 >	I	63	D < 27 >	I/O	115	VSS	—	167	VDD	_			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	12	VSS	_	64	VSS	_	116	-MEXC	I	168	VSS	-			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	13	CLK_ECB	I	65	D < 26 >	I/O	117	-READY	0	169	ADR < 6 >	0			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	14	TDI	I	66	D < 25 >	I/O	118	VSS	—	170	ADR < 7 >	0			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	15	-TRST	1	67	D < 24 >	I/O	119	VDD	—	171	N.C.	—			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	16	TCK	1	68	VSS	_	120	–BGRNT	0	172	ADR < 8 >	0			
18 VDD - 70 VDD - 122 -ERROR O 174 VSS - 19 VSS - 72 D<23> I/O 124 N.C. - 176 ADR 0 20 VSS - 72 D<23> I/O 124 N.C. - 176 ADR 0 0 21 VDD - 74 VSS - 126 -AS 0 177 N.C. - 22 VSS - 76 D<22> I/O 127 N.C. - 179 ADR< <td>12> 0 24 TDO 0 76 D<20> I/O 128 VSS - 181 ADR<<td>12> 0 26 VDD - 78 D<19> I/O 130 VSS - 184 ADR<<td>0 - 27 VSS - 79 VSS - 133 -CS - 184 ADR- 0 - 133 VSS - 184<!--</td--><td>17</td><td>TMS</td><td>I</td><td>69</td><td>VDD</td><td>_</td><td>121</td><td>VDD</td><td>_</td><td>173</td><td>ADR < 9 ></td><td>0</td></td></td></td>	12> 0 24 TDO 0 76 D<20> I/O 128 VSS - 181 ADR< <td>12> 0 26 VDD - 78 D<19> I/O 130 VSS - 184 ADR<<td>0 - 27 VSS - 79 VSS - 133 -CS - 184 ADR- 0 - 133 VSS - 184<!--</td--><td>17</td><td>TMS</td><td>I</td><td>69</td><td>VDD</td><td>_</td><td>121</td><td>VDD</td><td>_</td><td>173</td><td>ADR < 9 ></td><td>0</td></td></td>	12> 0 26 VDD - 78 D<19> I/O 130 VSS - 184 ADR< <td>0 - 27 VSS - 79 VSS - 133 -CS - 184 ADR- 0 - 133 VSS - 184<!--</td--><td>17</td><td>TMS</td><td>I</td><td>69</td><td>VDD</td><td>_</td><td>121</td><td>VDD</td><td>_</td><td>173</td><td>ADR < 9 ></td><td>0</td></td>	0 - 27 VSS - 79 VSS - 133 -CS - 184 ADR- 0 - 133 VSS - 184 </td <td>17</td> <td>TMS</td> <td>I</td> <td>69</td> <td>VDD</td> <td>_</td> <td>121</td> <td>VDD</td> <td>_</td> <td>173</td> <td>ADR < 9 ></td> <td>0</td>	17	TMS	I	69	VDD	_	121	VDD	_	173	ADR < 9 >	0
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	18	VDD	_	70	VDD	_	122	-ERROR	0	174	VSS	_			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	19	VSS	_	71	VDD	_	123	-LOCK	0	175	VDD	_			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	20	VSS	_	72	D < 23 >	I/O	124	N.C.	_	176	ADR < 10 >	0			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	21	VDD	_	73	D < 22 >	I/O	125	RD/WR	0	177	N.C.	_			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	22	VDD	_	74	VSS	_	126	-AS	0	178	ADR < 11 >	0			
24 TDO 0 TR TR <thtr< th=""> TR TR <th< td=""><td>23</td><td>VSS</td><td>_</td><td>75</td><td>D < 21 ></td><td>I/O</td><td>127</td><td>NC</td><td>_</td><td>179</td><td>ADR < 12 ></td><td>0</td></th<></thtr<>	23	VSS	_	75	D < 21 >	I/O	127	NC	_	179	ADR < 12 >	0			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	24	TDO	0	76	D < 20 >	1/0	128	VSS	_	180	VDD	_			
26VDD78D<19>VO130VSS182VDD27VSS79VSS131-CS<0>0183VSS28VDD80D<18>V/O132N.C184ADR<14>O29XTAL2O81N.C133-CS<1>O185VSS30XTAL1I82D<17>I/O134VSS186ADR<15>O31VSS83D<16>I/O135-CS<2>O187ADR<16>O32N.C84VDD136-CS<3>O188N.C33CLKOUT1O85VSS138N.C190VSS34VDD86VDD138N.C190VSS35CLKOUT2O87D<14>I/O141-SAME_PAGEO193ADR<19>O38VDD90D<13>I/O142VDD196ADR<21>O38VDD91D<12>I/O143VSS196ADR<21>O39VSS91D<12>I/O144VDD196ADR<21>O41-EMU_BRKI93<	25	-TIMER OVE	õ	77	VDD		129	VSS	_	181	ADR < 13 >	0			
1010010010010010010010010010010027VSS-80D < 18>1/0132N.C184ADR < 14 >029XTAL2081N.C133-CS < 1 >0185VSS-30XTAL1I82D < 17 >1/0134VSS-186ADR < 15 >031VSS-83D < 16 >1/0135-CS < 2 >0187ADR < 16 >032N.C84VDD-136-CS < 3 >0188N.C33CLKOUT1085VSS-137-CS < 4 >0189ADR < 17 >034VDD-86VDD-138N.C190VSS-35CLKOUT2087D < 15 >1/0139VDD-191VDD-36VSS-88N.C140-CS < 5 >0192ADR < 18 >037N.C89D < 14 >1/0141-SAME_PAGE0193ADR < 20 >038VDD-91D < 12 >1/0143VSS-195N.C40N.C92D < 11 >1/0144VDD-196ADR < 21 >041<	26		_	78	D < 19 >	1/0	130	VSS	_	182		_			
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	20	VSS		70	VSS		130	-05-05	0	183	VSS				
29XTAL2081N.C133-CS <1>0185XSS-30XTAL1I82D <17>I/O134VSS-186ADR <15>O31VSS-83D <16>I/O135-CS <1>O187ADR <16>O32N.C84VDD-136-CS <3>O188N.C33CLKOUT1085VSS-137-CS <4>O189ADR <17>O34VDD-86VDD-138N.C190VSS-35CLKOUT2087D <15>I/O139VDD-191VDD-36VSS-88N.C140-CS <5>O192ADR <18>O38VDD-90D <13>I/O141-SAME_PAGEO193ADR <19>O38VDD-92D <11>I/O144VDD-194ADR <20>O39VSS-91D <12>I/O143VSS-197VDD-40N.C92D <11>I/O144VDD-196ADR <21>O41-EMU_BRKI93VSS-145N.C197VDD-42VSS-94D <10	20			80	D < 18 >	1/0	122	NC	0	19/		0			
230XTAL20010N.C100V33-30XTAL1I82D<17>I/O134VSS-186ADR<15>O31VSS-83D<16>I/O135-CS<2>O187ADR<16>O32N.C84VDD-136-CS<3>O188N.C33CLKOUT1085VSS-137-CS<4>O189ADR<17>O34VDD-86VDD-138N.C190VSS-35CLKOUT2087D<15>I/O139VDD-191VDD-36VSS-88N.C140-CS<5>O192ADR<18>O37N.C89D<14>I/O141-SAME_PAGEO193ADR<20>O38VDD-90D<13>I/O142VDD-194ADR<20>O39VSS-91D<12>I/O143VSS-197VDD-40N.C92D<11>I/O144VDD-196ADR<21>O41-EMU_BRKI93VSS-145N.C197VDD-43VDD-95D<9>I/O147VS	20		_	00 91		1/0	122	09 < 1 >	_	195	ADIX < 14 >	0			
30ATALI132D < 1/31/0134VSS186ADR < 15 >031VSS83D < 16 >1/0135-CS < 2 >0187ADR < 16 >032N.C84VDD136-CS < 3 >0188N.C33CLKOUT1085VSS137-CS < 4 >0189ADR < 17 >034VDD86VDD138N.C190VSS35CLKOUT2087D < 15 >1/0139VDD191VDD36VSS88N.C140-CS < 5 >0192ADR < 18 >037N.C89D < 14 >1/0141-SAME_PAGE0193ADR < 19 >038VDD90D < 13 >1/0142VDD196ADR < 21 >038VDD92D < 11 >1/0144VDD196ADR < 22 >039VSS91D < 12 >1/0144VDD196ADR < 22 >041-EMU_BRK193VSS145N.C197VDD42VSS94D < 10 >1/0146-BE < 3 >0198VSS <td>29</td> <td>XTALZ</td> <td>0</td> <td>01</td> <td>N.C.</td> <td>-</td> <td>100</td> <td>-03 < 1 ></td> <td>0</td> <td>100</td> <td></td> <td>_</td>	29	XTALZ	0	01	N.C.	-	100	-03 < 1 >	0	100		_			
31VSS83 $D < 16 >$ I/O 135 $-CS < 2 >$ 0187 $ADR < 16 >$ 032N.C84 VDD 136 $-CS < 3 >$ 0188 $ADR < 17 >$ 033CLKOUT1085VSS137 $-CS < 4 >$ 0189 $ADR < 17 >$ 034VDD86VDD138 $N.C.$ 190VSS35CLKOUT2087 $D < 15 >$ I/O 139VDD191VDD36VSS88 $N.C.$ 140 $-CS < 5 >$ 0192 $ADR < 18 >$ 037N.C89 $D < 14 >$ I/O 141 $-SAME_PAGE$ 0193 $ADR < 19 >$ 038VDD90 $D < 13 >$ I/O 142VDD196 $ADR < 20 >$ 039VSS91 $D < 12 >$ I/O 143VSS195 $N.C.$ 40N.C92 $D < 11 >$ I/O 144 VDD 196 $ADR < 21 >$ 041-EMU_BRKI93VSS145 $N.C.$ 197VDD42VSS94 $D < 10 >$ I/O 144VDD196 $ADR < 22 >$ 043VDD95 $D < 9 >$ $I/$	30	XIALI VOO	I	02	D<17>	1/0	134	V35	_	100	ADR < 15 >	0			
32N.C84VDD136 $-CS<3>$ 0188N.C33CLKOUT1085VSS137 $-CS<4>$ 0189 $ADR<17>$ 034VDD86VDD138N.C190VSS35CLKOUT2087D<15>I/O139VDD191VDD36VSS88N.C140 $-CS<5>$ 0192 $ADR<18>$ 037N.C89D<14>I/O141 $-SAME_PAGE$ 0193 $ADR<19>$ 038VDD90D<13>I/O142VDD194 $ADR<20>$ 039VSS91D<12>I/O143VSS195N.C40N.C92D<11>I/O144VDD196 $ADR<21>$ 041-EMU_BRKI93VSS145N.C197VDD42VSS94D<10>I/O146-BE<3>0198VSS43VDD95D<9>I/O147VSS199ADR<22>044EMU_SD<	31	V55	_	83	D < 16 >	1/0	135	-05<2>	0	187	ADR < 16 >	0			
33CLKOUT1085VSS-137-CS<4>0189ADR<17>034VDD-86VDD-138N.C190VSS-35CLKOUT2087D<15>I/O139VDD-191VDD-36VSS-88N.C140-CS<5>0192ADR<18>037N.C89D<14>I/O141-SAME_PAGE0193ADR<19>038VDD-90D<13>I/O142VDD-194ADR<20>039VSS-91D<12>I/O143VSS-195N.C40N.C92D<11>I/O144VDD-196ADR<21>041-EMU_BRKI93VSS-145N.C197VDD-42VSS-94D<10>I/O144VDD-198VSS-43VDD-95D<9>I/O147VSS-199ADR<22>044EMU_SD-95D<9>I/O148-BE<2>0200ADR<23>045EMU_SD-10098VSS-150-BE<0>0202ADR<25>046EMU_SD-100VDD<	32	N.C.	_	84	VDD	_	136	-05<3>	0	188	N.C.	_			
34VDD-86VDD-138N.C190VSS-35CLKOUT2087D < 15 >I/O139VDD-191VDD-36VSS-88N.C140-CS < 5 >0192ADR < 18 >037N.C89D < 14 >I/O141-SAME_PAGE0193ADR < 19 >038VDD-90D < 13 >I/O142VDD-194ADR < 20 >039VSS-91D < 12 >I/O143VSS-195N.C40N.C92D < 11 >I/O144VDD-196ADR < 21 >041-EMU_BRKI93VSS-145N.C197VDD-42VSS-94D < 10 >I/O146-BE < 3 >0198VSS-43VDD-95D < 9 >I/O147VSS-199ADR < 22 >044EMU_SD < 3 >I/O96D < 8 >I/O148-BE < 2 >0201ADR < 24 >045EMU_SD < 1 >I/O98VSS-150-BE <0 >0203VSS-46EMU_SD < 0 >I/O98VSS-151ASI < 0 >0203VSS- <td>33</td> <td>CLKOUTI</td> <td>0</td> <td>85</td> <td>VSS</td> <td>_</td> <td>137</td> <td>-CS < 4 ></td> <td>0</td> <td>189</td> <td>ADR < 17 ></td> <td>0</td>	33	CLKOUTI	0	85	VSS	_	137	-CS < 4 >	0	189	ADR < 17 >	0			
35 CLKOUI2 0 87 D < 15 > I/O 139 VDD — 191 VDD — 36 VSS — 88 N.C. — 140 -CS < 5 > 0 192 ADR < 18 > 0 37 N.C. — 89 D < 14 > I/O 141 -SAME_PAGE 0 193 ADR < 19 > 0 38 VDD — 90 D < 13 > I/O 142 VDD — 194 ADR < 20 > 0 39 VSS — 91 D < 12 > I/O 143 VSS — 195 N.C. — 40 N.C. — 92 D < 11 > I/O 144 VDD — 196 ADR < 21 > O 41 -EMU_BRK I 93 VSS — 1445 N.C. — 197 VDD — 42 VSS — 94 D < 10 > I/O 146 -BE < 3 > O 198 VSS — 43 <	34	VDD	_	86	VDD		138	N.C.	_	190	VSS	_			
36VSS88N.C140-CS < 5>O192ADR < 18>O37N.C89D < 14>I/O141-SAME_PAGEO193ADR < 19>O38VDD90D < 13>I/O142VDD194ADR < 20>O39VSS91D < 12>I/O143VSS195N.C40N.C92D < 11>I/O144VDD196ADR < 21>O41-EMU_BRKI93VSS145N.C197VDD42VSS94D < 10>I/O146-BE < 3>O198VSS43VDD95D < 9>I/O147VSS199ADR < 22>O44EMU_SD < 3>I/O96D < 8>I/O148-BE < 2>O200ADR < 23>O45EMU_SD < 2>I/O97VDD149-BE < 1>O201ADR < 24>O46EMU_SD < 1>I/O98VSS151ASI < 0>O203VSS48VDD100VDD152VSS204VDD48VDD100VDD153VDD205VDD <td>35</td> <td>CLKOUT2</td> <td>0</td> <td>87</td> <td>D < 15 ></td> <td>I/O</td> <td>139</td> <td>VDD</td> <td>_</td> <td>191</td> <td>VDD</td> <td>_</td>	35	CLKOUT2	0	87	D < 15 >	I/O	139	VDD	_	191	VDD	_			
37N.C89D < 14 >I/O141-SAME_PAGEO193ADR < 19 >O38VDD-90D < 13 >I/O142VDD-194ADR < 20 >O39VSS-91D < 12 >I/O143VSS-195N.C40N.C92D < 11 >I/O144VDD-196ADR < 21 >O41-EMU_BRKI93VSS-145N.C197VDD-42VSS-94D < 10 >I/O146-BE < 3 >O198VSS-43VDD-95D < 9 >I/O146-BE < 3 >O198VSS-44EMU_SD < 3 >I/O96D < 8 >I/O147VSS-199ADR < 22 >O44EMU_SD < 2 >I/O97VDD-149-BE < 1 >O201ADR < 24 >O45EMU_SD < 1 >I/O98VSS-150-BE < 0 >O202ADR < 25 >O46EMU_SD < 1 >I/O98VSS-151ASI < 0 >O203VSS-48VDD-100VDD-152VSS-204VDD-48VDD-100VDD-152VSS-206VSS- </td <td>36</td> <td>VSS</td> <td>_</td> <td>88</td> <td>N.C.</td> <td></td> <td>140</td> <td>-CS < 5 ></td> <td>0</td> <td>192</td> <td>ADR < 18 ></td> <td>0</td>	36	VSS	_	88	N.C.		140	-CS < 5 >	0	192	ADR < 18 >	0			
38 VDD - 90 D < 13 > I/O 142 VDD - 194 ADR < 20 > O 39 VSS - 91 D < 12 > I/O 143 VSS - 195 N.C. - 40 N.C. - 92 D < 11 > I/O 144 VDD - 196 ADR < 21 > O 41 -EMU_BRK I 93 VSS - 145 N.C. - 196 ADR < 21 > O 42 VSS - 94 D < 10 > I/O 144 VDD - 196 ADR < 22 > O 43 VDD - 95 D < 9 > I/O 147 VSS - 199 ADR < 22 > O 43 VDD - 96 D < 8 > I/O 144 VSS - 199 ADR < 22 > O 44 EMU_SD < 3 > I/O 96 D < 8 > I/O 148 -BE < 2 > O 201 ADR < 22 > O	37	N.C.	_	89	D < 14 >	I/O	141	-SAME_PAGE	0	193	ADR < 19 >	0			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	38	VDD	_	90	D < 13 >	I/O	142	VDD	—	194	ADR < 20 >	0			
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	39	VSS	_	91	D < 12 >	I/O	143	VSS	—	195	N.C.	-			
41 -EMU_BRK I 93 VSS 145 N.C. 197 VDD 42 VSS 94 D < 10 > I/O 146 -BE < 3 > O 198 VSS 43 VDD 95 D < 9 > I/O 147 VSS 199 ADR < 22 > O 44 EMU_SD < 3 > I/O 96 D < 8 > I/O 148 -BE < 2 > O 200 ADR < 23 > O 45 EMU_SD < 2 > I/O 97 VDD 149 -BE < 1 > O 201 ADR < 24 > O 46 EMU_SD < 1 > I/O 98 VSS 151 ASI < 0 > O 202 ADR < 25 > O 47 VSS 99 VSS 151 ASI < 0 > O 203 VSS 48 VDD 100 VDD 152 VSS 204 VDD - <t< td=""><td>40</td><td>N.C.</td><td>—</td><td>92</td><td>D < 11 ></td><td>I/O</td><td>144</td><td>VDD</td><td>—</td><td>196</td><td>ADR < 21 ></td><td>0</td></t<>	40	N.C.	—	92	D < 11 >	I/O	144	VDD	—	196	ADR < 21 >	0			
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	41	-EMU_BRK	I	93	VSS	—	145	N.C.	—	197	VDD	—			
43 VDD 95 D < 9 > I/O 147 VSS 199 ADR < 22 > O 44 EMU_SD < 3 > I/O 96 D < 8 > I/O 148 -BE < 2 > O 200 ADR < 23 > O 45 EMU_SD < 2 > I/O 97 VDD 149 -BE < 1 > O 201 ADR < 24 > O 46 EMU_SD < 1 > I/O 98 VSS 150 -BE < 0 > O 202 ADR < 25 > O 47 VSS 99 VSS 151 ASI < 0 > O 203 VSS 48 VDD 100 VDD 152 VSS 204 VDD 49 EMU_SD < 0 > I/O 101 D < 7 > I/O 153 VDD 205 VDD 50 EMU_D < 3 > I/O 102 D < 6 > I/O 154 ASI < 1 > O 206 VSS <	42	VSS	_	94	D < 10 >	I/O	146	–BE < 3 >	0	198	VSS	_			
44 EMU_SD < 3 > 1/0 96 D < 8 > 1/0 148 -BE < 2 > O 200 ADR < 23 > O 45 EMU_SD < 2 > 1/0 97 VDD 149 -BE < 1 > O 201 ADR < 23 > O 46 EMU_SD < 1 > 1/0 98 VSS 150 -BE < 0 > O 202 ADR < 25 > O 47 VSS 99 VSS 151 ASI < 0 > O 203 VSS 48 VDD 100 VDD 152 VSS 204 VDD 49 EMU_SD < 0 > 1/0 102 D < 6 > 1/0 154 ASI < 1 > O 206 VSS 50 EMU_D < 2 > 1/0 103 N.C. 155 ASI < 2 > O 207 ADR < 26 > O 51 EMU_D < 1 > 1/0 104 D < 5 > 1/0 156 ASI < 3 > O 208 ADR < 27 > O <td>43</td> <td>VDD</td> <td>—</td> <td>95</td> <td>D < 9 ></td> <td>I/O</td> <td>147</td> <td>VSS</td> <td>—</td> <td>199</td> <td>ADR < 22 ></td> <td>0</td>	43	VDD	—	95	D < 9 >	I/O	147	VSS	—	199	ADR < 22 >	0			
45 EMU_SD < 2 > I/O 97 VDD 149 -BE < 1 > O 201 ADR < 24 > O 46 EMU_SD < 1 > I/O 98 VSS 150 -BE < 0 > O 202 ADR < 25 > O 47 VSS 99 VSS 151 ASI < 0 > O 203 VSS 48 VDD 100 VDD 152 VSS 204 VDD 49 EMU_SD < 0 > I/O 101 D < 7 > I/O 153 VDD 205 VDD 50 EMU_D < 3 > I/O 102 D < 6 > I/O 154 ASI < 1 > O 206 VSS 51 EMU_D < 2 > I/O 103 N.C. 155 ASI < 2 > O 207 ADR < 26 > O 52 EMU D < 1 > I/O 104 D < 5 > I/O 156 ASI < 3 > O 208 ADR < 27 > O </td <td>44</td> <td>$EMU_SD < 3 >$</td> <td>I/O</td> <td>96</td> <td>D < 8 ></td> <td>I/O</td> <td>148</td> <td>–BE < 2 ></td> <td>0</td> <td>200</td> <td>ADR < 23 ></td> <td>0</td>	44	$EMU_SD < 3 >$	I/O	96	D < 8 >	I/O	148	–BE < 2 >	0	200	ADR < 23 >	0			
46 EMU_SD < 1 > I/O 98 VSS 150 -BE < 0 > 0 202 ADR < 25 > 0 47 VSS 99 VSS 151 ASI < 0 > 0 203 VSS 48 VDD 100 VDD 152 VSS 204 VDD 49 EMU_SD < 0 > I/O 101 D < 7 > I/O 153 VDD 205 VDD 50 EMU_D < 3 > I/O 102 D < 6 > I/O 154 ASI < 1 > O 206 VSS 51 EMU_D < 2 > I/O 103 N.C. 155 ASI < 2 > O 207 ADR < 26 > O 52 EMU D < 1 > I/O 104 D < 5 > I/O 156 ASI < 3 > O 208 ADR < 27 > O	45	EMU_SD < 2 >	I/O	97	VDD	_	149	–BE < 1 >	0	201	ADR < 24 >	0			
47 VSS - 99 VSS - 151 ASI < 0 > O 203 VSS - 48 VDD - 100 VDD - 152 VSS - 204 VDD - 49 EMU_SD < 0 > I/O 101 D < 7 > I/O 153 VDD - 205 VDD - 50 EMU_D < 3 > I/O 102 D < 6 > I/O 154 ASI < 1 > O 206 VSS - 51 EMU_D < 2 > I/O 103 N.C. - 155 ASI < 2 > O 207 ADR < 26 > O 52 EMU_D < 1 > I/O 104 D < 5 > I/O 156 ASI < 3 > O 208 ADR < 27 > O	46	EMU_SD < 1 >	I/O	98	VSS	_	150	–BE < 0 >	0	202	ADR < 25 >	0			
48 VDD - 100 VDD - 152 VSS - 204 VDD - 49 EMU_SD < 0 > 1/0 101 D < 7 > 1/0 153 VDD - 205 VDD - 50 EMU_D < 3 > 1/0 102 D < 6 > 1/0 154 ASI < 1 > O 206 VSS - 51 EMU_D < 2 > 1/0 103 N.C. - 155 ASI < 2 > O 207 ADR < 26 > O 52 EMU D < 1 > 1/0 104 D < 5 > 1/0 156 ASI < 3 > O 208 ADR < 27 > O	47	VSS	_	99	VSS	_	151	ASI < 0 >	0	203	VSS	_			
49 EMU_SD < 0 > 1/0 101 D < 7 > 1/0 153 VDD 205 VDD 50 EMU_D < 3 > 1/0 102 D < 6 > 1/0 154 ASI < 1 > 0 206 VSS 51 EMU_D < 2 > 1/0 103 N.C. 155 ASI < 2 > 0 207 ADR < 26 > 0 52 EMU D < 1 > 1/0 104 D < 5 > 1/0 156 ASI < 3 > 0 208 ADR < 27 > 0	48	VDD	_	100	VDD	_	152	VSS	_	204	VDD	_			
50 EMU_D < 3 > 1/0 102 D < 6 > 1/0 154 ASI < 1 > 0 206 VSS - 51 EMU_D < 2 > 1/0 103 N.C. - 155 ASI < 2 > 0 207 ADR < 26 > 0 52 EMU_D < 1 > 1/0 104 D < 5 > 1/0 156 ASI < 3 > 0 208 ADR < 27 > 0	49	EMU_SD < 0 >	I/O	101	D < 7 >	I/O	153	VDD	_	205	VDD	_			
51 EMU_D<2> I/O 103 N.C. — 155 ASI<2> O 207 ADR<26> O 52 EMU_D<1> I/O 104 D<5> I/O 156 ASI<3> O 208 ADR<27> O	50	EMU D < 3 >	I/O	102	D < 6 >	I/O	154	ASI < 1 >	0	206	VSS	_			
52 EMU D < 1 > 1/Q 104 D < 5 > 1/Q 156 ASI < 3 > 0 208 ADR < 27 > 0	51	 EMUD < 2 >	I/O	103	N.C.	_	155	ASI < 2 >	0	207	ADR < 26 >	0			
	52		I/O	104	D < 5 >	I/O	156	ASI < 3 >	0	208	ADR < 27 >	0			

PIN ASSIGNMENT — 208-PIN QFP



VDD O 43	AD30 0 42	IRL3 O 41	IRL1 O 40	TDI O 39	-TMS O 38	TDO O 37	-TOVF O 36	XTL2 O 35	XTL1 O 34	CLO2 O 33	VSS 32	VDD O 31	EMUS1 O 30	VDD O 29
AD25 0 44	AD29 0 93	AD31 0 92	IRL2 O 91	CLKECB 90	тск О 89	VDD O 88	VDD O 87	VSS 86	VDD O 85	VSS 84	EMUS3 O 83	EMSU0 O 82	-EMEN O 81	VSS 28
AD22 0 45	VDD O 94	AD26 0 135	VSS	IRLO O 133	TRST O 132	VSS • 131	VDD 0 130	CLO1 - O 129	-EMBRK O 128	EMUS2 O 127	EMUD3 O 126	EMUD2 O 125	VDD O 80	D29 O 27
AD19 0 46	AD23 0 95	VSS 136	AD28 0 169	VDD O 168	VSS • 167	VDD 0 166	VSS 165	VDD 0 164	VSS • 163	VSS • 162	EMUD0 O 161	D31 O 124	VDD O 79	D28 0 26
AD18 O 47	AD21 0 96	AD24 0 137	VSS • 170	AD27 0 179						EMUD1 O 178	D30 O 160	D27 0 123	D26 O 78	D25 O 25
AD16 O 48	AD20 0 97	VDD O 138	VSS • 171								VSS	D24 O 122	VSS • 77	VDD O 24
AD15 0 49	AD17 0 98	VSS	VDD 0 172								VDD O 158	D23 0 121	D22 O 76	D21 O 23
AD13 O 50	AD14 0 99	VDD O 140	VSS • 173								VSS	D19 0 120	D18 O 75	D20 O 22
AD12 O 51	AD11 0 100	AD10 0 141	VDD O 174								VDD O 156	VSS • 119	VDD O 74	D17 O 21
VSS O 52	AD9 0 101	AD8 0 142	VSS 0 175								VSS	D11 0 118	D13 O 73	D16 0 20
AD7 O 53	AD6 0 102	VDD O 143	AD2 0 176							D5 0 177	VSS 154	D8 0 117	D12 O 72	D15 0 19
AD5 O 54	AD4 O 103	ASI7 O 144	VDD O 145	VSS 146	VSS 147	VDD O 148	VSS 149	VDD 0 150	VSS 151	D1 0 152	D4 O 153	D7 0 116	D9 0 71	D14 0 18
AD3 O 55	ASI6 O 104	ASI3 O 105	ASI2 0 106	-BE0 0 107	-BE3 O 108	-CS4 O 109	VSS 110	-ERR 0 111	VSS 112	-BRBQ O 113	D2 0 114	D6 0 115	VDD O 70	D10 O 17
ASI5 O 56	ASI4 O 57	ASI1 O 58	-BE1 O 59	VDD 60	VSS 61	-CS3 O 62	-CS0 63	-LOCK O 64	VDD 65	-MEXC O 66	VDD 67	D3 0 68	VSS 69	VDD O 16
VDD 0 1	O_2^{ASI0}	O 3	O_4^{-SP}	-CS5 0 5	-CS2 0 6	O_7^{-CS1}	O 8	9 O 9	O 10	-RDY O 11	O_{12}^{-RST}	D0 0 13	VDD 0 14	VSS 15

MB86930 179 PGA Pin Assignment (Top View)



BLOCK DIAGRAM





SIGNAL DESCRIPTIONS

SYMBOL	TYPE	DESCRIPTION
-RESET	I A (L)	SYSTEM RESET: Asserting reset for at least 4 processor cycles after the clock has stabilized, causes the MB86930 to be initialized.
XTAL1, (CLK_IN) XTAL2	I/O O G (Q) I (Q)	EXTERNAL OSCILLATOR: The crystal inputs determine execution rate and timing of the MB86930 processor. Connecting a crystal to these pins forms a complete crystal oscillator circuit. The crystal oscillator frequency is the same as the processor operating frequency. When driving the processor with an external clock, XTAL2 pin should be left floating.
CLKOUT1	O G (Q) I (Q)	CLOCK OUTPUT 1: This is an output signal against which MB86930 bus transactions can be referenced. The CLKOUT1 frequency is the same as the frequency applied to XTAL1 and is the same as the processor operating frequency. CLKOUT1 is in phase with CLK_IN.
CLKOUT2	O G (Q) I (Q)	CLOCK OUTPUT 2: This is an output signal against which MB86930 bus transactions can be referenced. The CLKOUT2 frequency is the same as the frequency applied to XTAL1 and is the same as the processor operating frequency. CLKOUT2 is out of phase with CLK_IN.
-LOCK	O S (L) G (Z) I (1)	BUS LOCK: This is a control signal asserted by the processor to indicate to the system that the current bus transaction requires more than one transfer on the bus. The Atomic Load Store instruction for example requires contiguous bus transactions which cause the assertion of the bus lock signal. The bus may not be granted to another bus owner as long as –LOCK is active. –LOCK is asserted with the assertion of –AS and remains active until –READY is asserted at the end of the locked transaction.
-BREQ	l S (L)	BUS REQUEST: Asserted by another device on the bus to indicate that it wants ownership of the bus. The request must be answered with a bus grant (–BGRNT) from the MB86930 before the device can proceed by driving the bus. Once the bus has been granted, the device has ownership of the bus until it de–asserts –BREQ. The user should ensure that devices on the bus cannot monopolize the bus to the exclusion of the CPU. Inputs to –BREQ while –RESET is active are valid and cause Bus Grant to be asserted.
-BGRNT	O S (L) G (0) I (Q)	BUS GRANT: Asserted by the CPU in response to a request from a device wanting ownership of the bus. The CPU grants the bus to other devices only after all transfers for the current transaction are completed. See the "Note" section at the end of this table and the "Type" column for other signals to determine the effect due to the assertion of –BGRNT.
-ERROR	O A (L) G (Q) I (Q)	ERROR SIGNAL: Asserted by the CPU to indicate that it has halted in an error state as a result of encountering a synchronous trap while traps are disabled. In this situation the CPU saves the PC and nPC registers, sets the tt value in the TBR, enters into an error state and asserts the –ERROR signal. The system can monitor the –ERROR pin and initiate a reset under the error condition. This pin is high on reset.
-MEXC	l S (L)	MEMORY EXCEPTION: Asserted by the memory system to indicate a memory error on either a data or instruction access. Assertion of this signal initiates either a data or instruction access exception trap in the IU. The current bus access is invalidated by asserting the –MEXC in the same cycle as the –READY signal. Assertion in any other bus cycle gives indeterminate results. The IU ignores the contents of the data bus in cycles where –MEXC is asserted.
IRL < 3:0>	I S (L)	INTERRUPT REQUEST BUS: The value on these pins defines the external interrupt level. IRL < 3:0>=1111 forces a non-maskable interrupt. IRL value of 0000 indicates no pending interrupts. All other values indicate maskable interrupts as enabled in the PIL field of the processor status register (PSR). Interrupts should be latched and prioritized by external logic and should be held pending until acknowledged by the processor. An interrupt controller is available on the MB86940.

1. In the following descriptions, signal names preceded by a minus sign (–) indicate an active low state. Dual function pins have two names separated by a slash (/).



SIGNAL	DESCRI	PTIONS	(Continued))

SYMBOL	TYPE	DESCRIPTION				
-TIMER_OVF	O S (L) G (Q) I (Q)	TIMER UNDERFLOW: Asserted by the processor to indicate that the internal 16–bit timer has underflowed. This signal can be used to initiate a DRAM refresh cycle or a one cycle periodic waveform. On reset, the timer is turned off and –TIMER_OVF is high.				
-SAME_PAGE	O S (L) G (1) I (1)	SAME-PAGE DETECT: The -SAME_PAGE is used to take advantage of fast consecutive accesses within Fast Page Mode DRAM page boundaries. This signal is an output asserted by the processor when the current address is within the same page as the previous memory access. The -SAME_PAGE signal is asserted with -AS and remains active for one processor cycleSAME_PAGE is never asserted in the first transaction following a transaction by another device on the bus. The page size is specified by writing the SAME-PAGE MASK register.				
-CS0, -CS1, -CS2, -CS3, -CS4, -CS5	O S (L) G (1) I (1)	CHIP SELECTS: These outputs are asserted when the value on the address bus matches the address range in one of the corresponding ADDRESS RANGE registers. The signals are used to decode the current address into one of six address ranges. Address ranges should not overlap. Each address range has a corresponding wait specifier which is used to automatically assert the –READY signal after a user defined number of processor clock cycles. This allows a variety of memory and I/O devices with different access times to be connected to the MB86930 without the need for additional logic.				
ADR < 31:2>	O S (L) G (Z) I (1)	ADDRESS BUS: The 30-bit ADDRESS BUS (A31-A2) is an output which identifies the data or instruction address of a 32-bit word. Reads are always one word in size while byte, half-word, or word transaction sizes for writes is identified by separate byte-enable signals (-BE0-3). The address bus is valid for the duration of the bus transaction.				
ASI <7:0>	O S (L) G (Z) I (1)	ADDRESS SPACE IDENTIFIERS: The ADDRESS SPACE IDENTIFIERS are outputs which indicate to which of 256 available spaces the current ADDRESS BUS value corresponds. The ASI values are defined as follows:				
		ASI < 7:0> ADDRESS SPACE				
		0x1Control Registers0x2Instruction Cache Lock0x3Data Cache Lock0x4 - 0x7Application Definable0x8User Instruction Space0x9Supervisor Instruction Space0xAUser Data Space0xBSupervisor Data Space0xCInstruction Cache Tag RAM0xEData Cache Tag RAM0xFData Cache Data RAM0xFData Cache Data RAM0xFE - 0xFFReserved for Debug Hardware				
		The ASI values specified as "application definable" can be used by supervisor mode instructions such as Load Alternate and Store Alternate . The ASI value is available in the same cycle in which the corresponding address value is asserted on the address bus. The ASI pins are valid for the duration of the bus transaction. ASI values 0x8, 0x9, 0xA, and 0xB are cacheable.				



SIGNAL DESCRIPTIONS (Continued)

SYMBOL	TYPE	DESCRIPTION
-BE3-0	0 S (L) G (Z) I (O)	BYTE ENABLES: These pins indicate whether the current store transaction is a byte, half-word or word transaction. –BE3–0 signals are available in the same cycle in which the corresponding address value is asserted on the address bus and is valid for the duration of the bus transaction. This bus should be used only to qualify store transactions. For load transactions all sub–word requests are read (and replaced in the cache) as words and then the appropriate byte or half–word is extracted by the integer unit. Possible values for –BE3–0 are as follows:
		31 Byte 0 24 23 Byte 1 16 15 Byte 2 8 7 Byte 3 0 Byte Writes 1 1 0 1 1 0 1 1 0 1 1 1 Half-Word 1 1 0 0 0 0 1 1 Word Writes 0 0 0 0 0
D < 31:0>	I/O S (L) G (Z) I (Z)	DATA BUS: The bus interface has 32 bidirectional data pins (D31–D0) to transfer data in thirty–two bit quantities. D(31) corresponds to the most significant bit of the least significant byte of the 32–bit word. A double word is aligned on an 8–byte boundary, a word is aligned on a 4–byte boundary, and a half–word is aligned on a 2–byte boundary. If a load or store of any of these quantities is not properly aligned, a Not Aligned Trap will occur in the processor. In write bus cycles, the point at which data is driven onto the bus depends on the type of the preceding cycle. If the preceding cycle was a write, data is driven in the cycle immediately following the cycle in which –READY was asserted. If the preceding cycle was a read, data is driven one cycle after the cycle in which –READY was asserted to minimize bus contention between the processor and the system. All bits of the data bus are driven regardless of word size. The values on the pins not corresponding to the byte or half–word being written are undefined.
-AS	O S (L) G (Z) I (1)	ADDRESS STROBE: A control signal asserted by the MB86930 or other bus master to indicate the start of a new bus transaction. A bus transaction begins with the assertion of –AS and ends with the assertion of –READY. –AS remains asserted for 1 clock cycle. During cycles in which neither the processor nor another bus master is driving the bus the bus is idle, and –AS remains de–asserted.
RD/-WR	O S (L) G (Z) I (1)	READ/BUS TRANSACTION: This signal specifies whether the current bus transaction is a read or a write operation. When –AS is asserted and RD/–WR is low, then the current transaction is a write. With –AS asserted and RD/–WR high, the current transaction is a read. RD/–WR remains active for the duration of the bus transaction and is de–asserted with the assertion of –READY.
-READY	I S (L)	READY: This is a control signal asserted by the external memory system to indicate that the current bus transaction is being completed and that it is ready to start with the next bus transaction in the following cycle. In case of a fetch from memory, the processor will strobe the value on the data bus at the rising edge of CLK_IN following the assertion of -READY. For the case of a write, the memory system will assert -READY when the appropriate access time has been met. In most cases, no additional logic is required to generate the -READY signal. On-chip circuitry can be programmed to assert -READY based on the address of the current transaction. The external system can override the internal ready generator to terminate the current bus cycle early. Up to 6 address ranges each with different transaction times can be programmed.
CLK_ECB	I	EXTERNAL CLOCK BYPASS: Tying this signal high causes the CLK_IN signal to bypass the Phases Lock Loop (PLL). This signal is used for testing of the chip.
EMU_SD < 3:0>	I/O	EMULATOR STATUS/DATA BITS: Bi–directional pins used by a hardware emulator to control and monitor MB86930 execution. These pins should be left unconnected.



SYMBOL	TYPE	DESCRIPTION			
EMU_D < 3:0>	I/O	EMULATOR DATA BITS: Bi–directional pins used by a hardware emulator to control and monitor MB86930 execution. These pins should be left unconnected.			
-EMU_BRK	I	EMULATOR BREAK REQUEST LINE: Input used by a hardware emulator to request a trap when emulation is enabled. This pin should be left unconnected.			
-EMU_ENB I		EMULATOR ENABLE: Tied low while the MB86930 is being reset to enable hardware emulator mode on the chip. This pin should be left unconnected.			
тск	I	TEST CLOCK: JTAG compatible test clock input.			
TMS	I	TEST MODE: JTAG compatible test mode select pin.			
TDI	I	TEST DATA IN: JTAG compatible test data input.			
TDO	0	TEST DATA OUT: JTAG compatible test data output.			
-TRST I TEST RESET: Asynchrono pulled low.		TEST RESET: Asynchronous reset for JTAG logic. If not using JTAG, this signal must be pulled low.			
NOTE: I = Inpu O = Out	t Only Pin put Only Pin	G() = While the bus is granted to another bus master (-BGRNT=asserted), the pir is is			

SIGNAL DESCRIPTIONS (Continued)

I/O = Either Input or Output Pin

– = Pins "must be" connected as described

A(L)= Asynchronous: Inputs may be asynchronous to CLKOUT.

S(L)= Synchronous: Inputs must meet setup and hold times relative to CLK_IN Outputs are Synchronous to CLK_IN

 $\begin{array}{l} G (1) \text{ is driven to } V_{CC} \\ G (0) \text{ is driven to } V_{SS} \\ G (Z) \text{ floats} \\ G (Q) \text{ is a valid output} \end{array}$

cycles (or being reset) and is not granted to another bus master, the pin is I (1) is driven to V_{CC} I (0) is driven to V_{SS} I (Z) floats I (Q) is a valid output



OVERVIEW

The Fujitsu MB86930 is a high–performance, 32–bit RISC processor which executes at 40 MIPs peak and 37 MIPs sustained performance with 40 MHz clock frequency. It is a fourth generation version of Fujitsu's popular MB86900, MB86901 and MB86902 processors. Like its predecessors, the MB86930 is based on the SPARC architecture and is upward code compatible with previous implementations. Most importantly, the MB86930 has been developed specifically with the needs of embedded applications in mind and offers high performance and high integration for these applications.

The MB86930 instruction set is streamlined and hardwired for fast execution with most instructions executing in a single cycle. The Integer Unit (IU) features a 5–stage pipeline which has been designed to handle data interlocks, has an optimized branch handler for efficient control transfers, and a bus interface to handle single cycle bus accesses to on–chip memory.

An internal register file consisting of 136 registers organized into eight overlapping windows speeds interrupt response time and context switches. The register file minimizes accesses to memory during procedure linkages and facilitates passing of parameters and assignment of variables.

On-chip 2 Kbyte data and instruction caches have been added to decouple the processor from external memory. These caches have been designed with maximum flexibility in mind and allow entries to be locked to improve overall system performance.

Separate 32–bit on–chip instruction and data paths provide a high bandwidth interface between the IU and on–chip cache. These buses support single cycle instruction execution as well as single cycle data transfers with the cache. Future expansion of the MB86930 design is supported by this bus definition as well.

The MB86930 also includes hardware for integer multiply and divide. The hardware support significantly improves the performance of these operations with 32–bit integer multiplies executing in 5 clock cycles, 16–bit integer multiplies in 3 cycles, 8–bit integer multiplies in 2 cycles, and a multiply by zero can complete in a single cycle.

KEY FEATURES

Fast Instruction Execution: Simple functions make up the bulk of instructions in most programs so that execution speed can be greatly improved by designing these instructions to execute in as short a time as possible. The majority of instructions execute in one cycle with only a few of the more complex, such as integer multiply, taking additional cycles.

Large Register Set: The large register set reduces the number of required accesses to data memory. The registers are organized in overlapping groups called register windows which allows registers to be reserved for high priority tasks, such as interrupts, or for recurring requirements such as operating system working registers. The overlapping windows also simplify parameter passing during procedure linkage and reduce code in most programs.

On–Chip Caches: To decouple the speed of the processor from the memory sub–system, data and instructions caches have been added. The caches are organized as two–way set–associative for improved hit rates. In addition, the set–associative caches allow entries to be locked, individually or as a bank, without significantly degrading the cache performance.

Cache Locking: Both data and instruction entries can be locked into their respective caches to ensure deterministic response and highest performance for critical or frequently recurring routines. Maximum flexibility has been designed into the cache to allow all or selected portions to be locked.

Bus Interface: The requirement for glue logic between the MB86930 and the system is minimized by providing programmable chip selects, programmable wait–state circuitry, and support for connection to fast page–mode DRAM. Multiple bus masters are supported through a simple handshake protocol.

Clock Generator: To simplify the clock design a crystal can be connected directly to the on-chip oscillator or an external clock source can be used. A built in phase-locked loop minimizes the skew between on and off-chip clocks.

Enhanced Instruction Set: The MB86930 incorporates a fast integer multiply instruction which executes in a fast 5, 3 or 2 cycles for 32–bit, 16–bit or 8–bit multiplicands. An integer divide–step instruction cuts divide times by a factor of 10 over previous SPARC implementations. A scan instruction supports a single cycle search for the most significant 1 or 0 in a word.



Fully Static Circuit Design: Embedded applications that need a means to reduce power consumption can take advantage of the MB86930's fully static design. The processor clock can be slowed or stopped for arbitrary periods of time to reduce operating current with no loss of internal state. Noise immunity is improved as well. (Note: stopping the clock will result in the Phase-Lock Loop losing lock. Lock must be re-established before normal operation can be resumed.)

Test and Debug Interface: The MB86930 supports production test through industry standard JTAG boundary scan. Hardware emulation is supported with on-chip breakpoint and single step logic. A dedicated emulator bus provides a means to trace transactions between the integer unit and on-chip cache.

CPU

The MB86930 core is a high performance full custom implementation of the SPARC architecture. The core is compact to leave room for peripheral integration and yet is designed in a way to allow the major blocks to be customized for varying application requirements. The core is made up of three functional units: the Instruction block, the Address block and the Execute block (see Figure 1).

A five stage instruction pipeline is responsible for decoding all instructions and generating the control signals to the other blocks. The 5-stage pipeline consists of Fetch (F), Decode (D), Execute (E), Memory (M) and Writeback (W). Instruction memory is addressed and returns instructions in the (F) stage, the register file is addressed and returns operands in the (D) stage, the ALU computes results in the (E) stage, external memory is addressed in the (M) stage, and the register file is written back in the (W) stage.

DATA MOVEMENT

TO USER/SUPERVISOR SPACE SIGNED

AND OR XOR AND NOT OR NOT XNOR	ADD SUBTRACT MULTIPLY(SIGNED/UNSIGNED) SCAN SETHI SHIFT LEFT LOGICAL SHIFT RIGHT LOGICAL SHIFT RIGHT ARITHMETIC	LOAD BYTE LOAD HALF-WORD LOAD WORD LOAD DOUBLE WORD STORE BYTE STORE HALF-WORD STORE WORD STORE DOUBLE WORD
CONDITION CODES SET AND OR XOR AND NOT OR NOT XNOR	CONDITION CODES SET ADD SUBTRACT MULTIPLY(SIGNED/UNSIGNED) MULTIPLY STEP DIVIDE STEP	TO USER SPACE UNSIGNED LOAD BYTE LOAD HALF-WORD TO ALTERNATE SPACE SIGNI LOAD BYTE LOAD HALF-WORD LOAD WORD
CONTROL TRANSFER	UNCHANGED	LOAD DOUBLE WORD
CONDITIONAL BRANCH CONDITIONAL TRAP CALL RETURN	ADD SUBTRACT EXTENDED AND CONDITION CODES SET	STORE BYTE STORE HALF–WORD STORE WORD STORE DOUBLEWORD
SAVE RESTORE	ADD SUBTRACT	TO ALTERNATE SPACE UNSIGI LOAD BYTE

READ Y

WRITE Y

ARITHMETIC/SHIFT

CONDITION CODES UNCHANGED

TABLE 1. MB86930 Instruction Set LOGICAL

CONDITION CODES UNCHANGED

JUMP AND LINK

READ PSR WRITE PSR

READ TBR

WRITE TBR

CODES SET	CONDITION CODES SET	TO USER SPACE UNSIGNED
D	ADD	LOAD BYTE
2	SUBTRACT	LOAD HALF–WORD
R NOT IOT DR	MULTIPLY(SIGNED/UNSIGNED) MULTIPLY STEP DIVIDE STEP	TO ALTERNATE SPACE SIGNED LOAD BYTE LOAD HALF-WORD
RANSFER	EXTENDED AND CONDITION CODES UNCHANGED	LOAD DOUBLE WORD
L BRANCH IAL TRAP L IRN /E ORE ID LINK	ADD SUBTRACT EXTENDED AND CONDITION CODES SET ADD SUBTRACT TAGGED AND CONDITION CODES SET (WITH AND WITHOUT TRAP ON OVERFLOW) ADD SUBTRACT	STORE BYTE STORE HALF-WORD STORE WORD STORE DOUBLEWORD TO ALTERNATE SPACE UNSIGNED LOAD BYTE LOAD HALF-WORD ATOMIC OPERATION IN USER SPACE SWAP WORD
READ/WRITE CO	NTROL REGISTER	
READ WRITI REA) WIM RDASR E WIM WRASR D Y	ALTERNATE SPACE SWAP WORD LOAD/STORE UNSIGNED BYTE

ADDRESS SPACE

The MB86930 offers a large addressing range and allows separate user and supervisor spaces to be defined. In addition to 32 address lines, 4 alternate address space identifiers (ASIs) distinguish between protected and unprotected space. Of the 256 possible ASI values, two define accesses to user data and user instruction space while the remaining ASI values define supervisor space.

Anytime a reset, synchronous trap or asynchronous trap occurs, the processor is placed into the supervisor mode. In this mode, the processor executes instructions and moves data out of supervisor space. While in supervisor mode, the processor also has access to the remaining ASI values. Except for those mentioned and those reserved for control register space, the remaining ASI values can be used to access other alternate data spaces defined by the application.

The distinction of user versus supervisor space allows the hardware to protect against accidental or un–authorized access to system resources. For real time operating system (RTOS) development for example, the separate spaces



provide a mechanism for effectively partitioning RTOS space from user space.

REGISTERS

The MB86930 register set is divided into those used for general purpose functions and those used for control and status.

The 136 general purpose registers are divided into 8 global registers and 8 overlapping blocks or "windows". Each window contains 24 registers. Of these, 8 are local to the window, 8 "out" registers overlap with the next window and 8 "in" registers overlap with the previous window (see Figure 2).

This organization makes it easy to pass parameters to subroutines. Parameters that are to be passed along are written to the "out" registers and the subsequent procedure call decrements the window pointer to make a new set of registers available. The passed parameters are now available to the subroutine in the current window's "in" registers.





Register windows improve performance in embedded applications because they function as local variable caches which retain either interrupt, subroutine, context or operating system variables with no additional overhead. In addition, code can be reduced by exploiting the efficient execution of procedure linkage by preventing in–lining compiler optimizations.

The registers that make up the register file each have three read—only and one write—only port. The use of a four port register file allows even store instructions, which may require that three operands be read out of the register file, to proceed at one instruction per cycle.

The control and status registers include those defined by the SPARC architecture (see Table 1) and those mapped into alternate address space to control peripheral functions (see Table 2).

INSTRUCTION SET

The MB86930 is upward code compatible with other SPARC processors. Additional instructions, previously not directly supported, have been added to improve performance in embedded applications. Integer multiply, integer divide step, and scan for first changed bit have been added to the already powerful SPARC instruction set. See Table 1 for a list of supported instructions.



INTERRUPTS

A key measure of a processor's suitability for use in embedded application is in its ability to handle interrupts with a minimum of delay and in a deterministic fashion. The MB86930 implementation has been tailored to insure not only low average latency but low maximum latency as well.

Interrupt response time is made up of the sum of the times it takes the processor to finish its current task after recognizing an interrupt, and the time it takes to begin executing interrupt service routine instructions. The MB86930 implements numerous features to minimize both factors.

To minimize the time it takes to finish the current task, the MB86930 is designed so that tasks can either be interrupted or completed in a minimum of cycles. Implementation details that accomplish this aim include cache line misses that are filled one word at a time through a pre–fetch buffer, integer divide that is interruptible through the use of a divide step instruction, fast multiply and a 1 word write buffer to limit pending bus transactions.

To minimize the time required to start executing the interrupt service routine the processor switches to a new register window when an interrupt is detected. This feature allows the service routine to be executed without first requiring that the current registers be saved. The user can also elect to lock the service routine into the cache. This makes the routine available for immediate access. The on-chip data cache can also serve the service routine as a fast local stack for minimum delay in accessing routine variables.

The MB86930 provides for up to 15 different interrupt levels and direct support for 15 separate interrupt sources. The highest interrupt level is non-maskable.

CACHE

The MB86930 has separate on-chip data and instruction caches. This allows the user to build a high performance system without incurring the cost of requiring fast external memory and the associated control logic.

The data and instruction caches are each organized as two banks of sixty-four 16-byte lines (see Figure 4). The lines are organized as two-way set-associative for good performance even when cache locking is in effect. Lines are divided into four sub-blocks each four bytes wide. On a cache miss, the cache is updated in sub-block increments for efficient re-fill of typical code segments and to avoid interrupt latency incurred by long cache line replacements. An instruction pre-fetch buffer fetches the next sequential instruction anticipating that it will be needed to fill the next instruction cache miss.



The caches can be used in either normal or one of two lock modes. In normal mode, the caches use an LRU (least recently used) algorithm to replace one of the two appropriate entries. Alternately, the two locking modes allow the entire cache or just selected entries to be locked. The lock modes allow time critical routines to be locked in cache.

Global locking allows the entire content of either the instruction or data cache to be frozen. Two control bits in the cache control register enable or disable locking for either cache. With the entire cache locked, no valid entry can be replaced. To insure best possible performance however, invalid entries will be updated if they are accessed. This is done automatically and incurs no time penalty.

Local cache locking makes it possible to dynamically lock selected instructions or data entries into the appropriate cache. This feature gives the flexibility, for example, to assure deterministic response for certain critical interrupt routines by locking the routine's code into the cache. Entries can also be locked where it is desirable to give performance priority to certain often used routines which might otherwise be removed from cache. The 2–way set–associativity allows the cache to perform effectively even with some locked entries.

In local lock mode, each entry can either be locked individually by software or automatically with hardware assist. For individual locking, software writes the lock bit in the appropriate cache tag line. For automatic locking, a bit in each cache control register enables or disables the feature. The enable bit is set at the beginning of a routine for which the entries are to be locked. This causes the location of any cache access occurring while the bit is enabled to be locked into the cache. In addition to requiring just one initial cycle to enable, automatic entry locking incurs no overhead while in effect.

In unlocked operation, the data cache uses a write– through update policy and allocates a cache entry only on a load. Writes are buffered so that the processor can continue executing while data is written back to memory. In contrast, writes to locked data cache locations are not written through to main memory. Besides reducing external bus activity, this design supports configuring a portion of data cache as on–chip RAM which does not map to external memory.

The data and instruction caches are designed to be accessed independently over separate data and instruction buses to allow data to be loaded from and stored to cache at peak rates of 1 CPI.

BUS INTERFACE

The Bus Interface Unit (BIU) is designed to simplify the interface between the MB86930 and the rest of the system. Separate address and data buses make it easy to build fast systems. At the same time, on-chip circuitry allows these systems to be built with a minimum of external hardware.

The bus interface supports fully programmable waitstate generation, address decoding with chip select outputs, same page detection to support page-mode DRAM, and an auto-reload timer to support a refresh counter.

CLOCK GENERATOR

The on-chip clock generator provides a means to directly connect the MB86930 to either a crystal oscillator or an external clock source. For either case, the external frequency is the same as the chip operating frequency.

A clock output signal provides the system with a reference by which external timing can be synchronized when not using an external clock source. The skew between the internal clock and an external input clock source is minimized by the inclusion of an on-chip phase lock loop circuit.





Processor State Register	PSR		
31 28 27	24 23	20 19 12	11 8 7 6 5 4 0
	icc		
0 0 0 0 0 0 1	0 n z v	c reserved	PIL
	\		
C	onditions		
n –	: (Negative=1, Non-I	Negative=0)	
z	: (Zero=1, Non-Zero	=0)	
¢.	: (Carry=1 No Carry	/=0)	
	· (call)=1, no call)		
F	Processor Interrupt Le	evel (Value 1–15, RST=Undefined)	
	S MODE (Super	visor=1, User=0, RST=Undefined)	
		Prior S Mode	
	Enable T	rap (Enable=1, Disable=0, RST=0	
	Current Window Poi	inter (Value=0-7, RST=Undefined)	
Window Invalid Mask	WIM		
		ļ	
31			8 7 6 5 4 3 2 1 0
	re	served	w7 w6 w5 w4 w3 w2 w1 w0
		Window Invalid Mask (Inva	alid=1, Valid=0, RST=Undefined)
Trap Base Register	TBR		
31		12	11 4 3 0
	Trap Base Addr	ess	Trap Type NULL
	(RSI=Undefined	1)	(RST=0)
Y Register	Y		
	-		
31			0
Annelliony State Deviator 47	ACD 47		
Ancillary State Register 17	ASR 17		
31			3 2 1 0
		record	
		reserved	
			Reserved (Must Write 0, RST=1)
			Reserved (Must Write 0, RST=1)
		Single Vector Tran	ping (Enabled=1, Disabled=0, RST=0)
		2	

TABLE 1. MB86930 Control and Status registers (All registers are read/write)



Cacl	he/BIU Control	31 5 4 3 2 1 0					
ASI	ADDRESS	reserved					
0x 1	0x 0000 0000	Write Buffer Enable (Enabled=1, Disabled=0, RST=0) Prefetch Buffer Enable (Enabled=1, Disabled=0, RST=0) Data Cache Lock (Lock=1, Unlock=0, RST=0) Data Cache Enable (Enabled=1, Disabled=0, RST=0) Instruction Cache Lock (Lock=1, Unlock=0, RST=0) Instruction Cache Enable (Enabled=1, Disabled=0, RST=0) Instruction Cache Enable (Enabled=1, Disabled=0, RST=0)					
L	ock Control	31 1.0					
ASI	ADDRESS	reserved					
0x 1	0x 0000 0004	Data Cache Entry Auto Lock (On=1, Off=0, RST=0)					
Loci	k Control Save	31 1 0					
ASI	ADDRESS	reserved					
0x 1	0x 0000 0008	Previous Instruction Cache Auto Lock (Off=0, On=1, RST=0)					
Cache Status		31 0					
ASI	ADDRESS	reserved					
0x 1	0x 0000 000C	Auto Lock Failed (False=0, True=1, RST=0)					
Resto	re Lock Control	31 0					
ASI	ADDRESS						
0x 1	0x 0000 0010	Restore Lock Control Register (Restore=1, Ignore=0, RST=0)					
System	Support Control	31 6.5.4.3.2.1.0					
ASI	ADDRESS	reserved					
0x 1	0x 0000 0080	reserved Same Page Enable (Enabled=1, Disabled=0, RST=0) Chip Select Enable (Enabled=1, Disabled=0, RST=0) Programmable Wait–State (Enabled=1, Disabled=0, RST=1) Timer On/Off (Enabled=1, Disabled=0, RST=0)					
Same Page Mask		31 30 23 22 1 0					
ASI	ADDRESS	ASI Mask Address Mask					
0x 1	0x 0000 0120	[Care=0, Don't Care=1, K51=0] [Care=0, Don't Care=1, K51=0]					

TABLE 2. MB86930 Memory Mapped Control Registers (All registers are read/write)



Address Range ¹		31 30 23 22 1 0							
ASI	ADDRESS	ASI < 7:0> ADR < 31:10> (PST=liptefind)							
0x 1	CS1 0x 0000 0124 CS2 0x 0000 0128 CS3 0x 0000 012C CS4 0x 0000 0130 CS5 0x 0000 0134	NOTE: CS0 is hardwired to ASI=0x9 ADR < 31:10> = < 00>							
Ac	ddress Mask	31 30 23 22 1 0							
ASI	ADDRESS	ASI Mask ADR < 31:10> Mask (0=Care, 1=Don't Care, OPT Under the form the							
0x 1	CS0 0x 0000 0140 CS1 0x 0000 0144 CS2 0x 0000 0148 CS3 0x 0000 014C CS4 0x 0000 0150 CS5 0x 0000 0154	NOTE: CS0 is hardwired to ASI=0x9; At Reset, ADR < 31:15> = 0, ADR < 14:10> = 1							
Wait	State Specifier	<u>31 27 26 25 24 23 22 21 20 19 18 14 13 9 8 7 6 5 0</u>							
ASI	ADDRESS	Count1 Count 2 Count1 Count2 reserved (RST=Undefined) (RST=Undefined) (RST=Undefined) reserved							
0x 1	CS1,CS0 0x 0000 0160 CS3,CS2 0x 0000 0164 CS5,CS4 0x 0000 0168	Wait Enable (On=1, Off=0, RST=0) Single Cycle (On=1, Off=0, RST=0) Override (On=1, Off=0, RST=0) (CS): RST=1)							
	Timer	31 16 15 0							
ASI	ADDRESS	reserved Timer Value							
0x 1	0x 0000 0174	(non-onterinted)							
Tin	ner Pre–Load	31 16 15 0							
ASI	ADDRESS	reserved Timer Pre-Load Value							
0x 1	0x 0000 0178	(K21=Undelined)							
Instruct	ion Tag Lock Bits	31 0							
ASI	ADDRESS	reserved							
0x 2	Bank 1 0x 0000 0000	Entry Lock (Locked=1, Unlocked=0, RST=Undefined)							
Data	Tag Lock Bits	31 0							
ASI ADDRESS		reserved							
0x 3	Bank 1 0x 0000 0000 ↓ by 4 0x 0000 0400 Bank 2 0x 8000 0000	Entry Lock (Locked=1, Unlocked=0, RST=Undefined)							
	bank 2 0x 8000 0000 ↓ by 4 0x 8000 0400								

1. This register is Write Only



TABLE 2. MB86930 Memory Mapped Control Registers (Continued)

Instruction Cache Tag		31 10 9 6 5 4 2 1 0
ASI	ADDRESS	ADDRESS TAG [RST=Undefined]
0x C	Bank 1 0x 0000 0000	Sub Block Valid (Valid=1, Invalid=0, RST=Undefined) User/Supervisor (User=0, Supervisor=1, RST=Undefined) Least Recently Used (RST=Undefined) Entry Lock (Locked=1, Unlocked=0, RST=Undefined)
Da	ta Cache Tag	31 10 9 6 5 4 2 1 0
ASI	ADDRESS	ADDRESS TAG [RST=Undefined]
0x E	Bank 1 0x 0000 0000	Sub Block Valid (Valid=1, Invalid=0, RST=Undefined) User/Supervisor (User=0, Supervisor=1, RST=Undefined) Least Recently Used (RST=Undefined) Entry Lock (Locked=1, Unlocked=0, RST=Undefined)
Instrue	ction Cache Data	31 0
ASI	ADDRESS	
0x D	Bank 1 0x 0000 0000	
Dat	ta Cache Data	31 0
ASI	ADDRESS	ADDRESS TAG [RST=Undefined]
0x F	Bank 1 0x 0000 0000	

FUJITSU

BUS OPERATION

The Bus Interface Unit (BIU) has the logic which allows the MB86930 to interface with the system. The system interface is made up of the address and data buses, the interrupt request bus and various control signals. The BIU is either handling requests for external memory operations, arbitrating for bus access, or idle.

Operation of the BIU

The BIU receives requests for external memory operations from the Cache Control Logic (CCL). In the case of reads from external memory, it performs the read operation and returns the data to the Cache and IU. A parallel path is used to make the data available to the IU in the same cycle that it is written to the cache.

In the case of a write to external memory, the BIU makes use of a write buffer which can hold a one word write transaction. When the BIU receives a request for a write transaction it stores the write data and address in the write buffer allowing the IU to continue operating out of on-chip cache and/or its register file. The BIU then proceeds to complete the write to external memory. In most cases the write buffer will hide external memory latency from the IU. The exceptions are in cases where the write buffer is still filled from a previous transaction or if the subsequent IU cycle results in an instruction cache miss. In these cases, IU execution is held until the write buffer is emptied.

The BIU includes a one stage prefetch buffer for instruction fetches. This buffer is used to fetch the next sequential instruction after an instruction cache miss. The instruction is prefetched only if the BIU does not have a request for a bus transaction from the IU nor is any external device requesting use of the bus. The prefetch buffer operation is suspended if the buffer is full. This occurs if the prefetched instruction is a hit in the instruction cache. The buffer restarts after another instruction prefetch, the exception occurs during an instruction prefetch, the exception is not sent to the IU unless the instruction is actually requested by the IU. The prefetch buffer operates only when the instruction cache is on.

In any cycle the BIU can receive a request for accesses to either or both instruction and/or data memory. If it receives a request for both in the same cycle, it completes the data memory transaction first.

Exception Handling

The external memory system can indicate an exception during a memory operation. The BIU signals the appropriate data or instruction exception to the IU which will trap accordingly. As mentioned above, the IU can continue operation after putting the data and address for a store in the write buffer. If an exception is detected while completing this buffered write, then the BIU indicates a data access exception to the IU.

Any system which needs to recover from this error should store the address and data of such write transactions in hardware. If the system can generate both read and write exceptions, then the system must also provide a status bit which indicates whether the exception was generated on a read or on a write transaction. With access to this information the data access exception service routine can determine the cause of the exception and recover accordingly.

Bus Cycles

Timings 1 through 9 illustrate representative combinations of bus cycles.

Load

Whenever an instruction fetch or a load from data memory has a miss in the cache, the BIU performs a read from external memory.

A read transaction begins with the BIU asserting -AS, to indicate a new bus transaction. The -AS signal is de–asserted after one cycle. At the same time the ADR < 31:2> and ASI < 7:0> bits are driven with the location to be read. The BIU drives the RD/–WR signal high to indicate a read transaction.

The external memory system responds with the read data on pins D < 31:0 >. It also asserts the –READY signal when the data is ready. For slow memory, the –READY signal can be delayed until data is valid.

A load double operation is treated as back-to-back reads.

Load with Exception

If the external memory system sees a memory exception it can terminate the current memory transaction by asserting the –MEXC and –READY signals. The data on the data bus is ignored by the MB86930.

Store

A write transaction begins with the BIU asserting –AS, to indicate a new bus transaction. The –AS signal is de–asserted after one phase. At the same time the ADR < 31:2> and ASI < 7:0> pins are driven with the location to be written while the D < 31:0> pins has corresponding write data. The –BE0–3 pins indicate byte, half–word or word transaction width. The BIU drives the RD/–WR signal low to indicate a write transaction.



The external memory system responds by asserting the –READY signal when it has stored the data.

A store double operation is treated as back-to-back writes.

Store with Exception

If an access exception occurs on a write, the external memory system can terminate the current memory transaction by asserting the –MEXC and –READY signals. The external memory system is expected to ignore the data on the data bus in this situation.

Atomic Load Store

An atomic load store executes as a load followed by a store with no operation allowed in between. The –LOCK

signal is asserted to indicate that the bus is being used for more than one external memory operation.

There is one cycle between the termination of the read and the beginning of the write to provide time for the switching of the data bus drivers.

External Bus Request and Grant

Any external device can request ownership of the bus by asserting the –BREQ signal. The BIU asserts the –BGRNT signal to indicate that it is relinquishing control of the bus and also three–states all of its bus drivers. In the following cycle, the external device can complete its transaction. On completion of its transaction the external device de–asserts the –BREQ signal. The BIU responds by de–asserting the –BGRNT signal in the following cycle.

The MB86930 is the default owner of the bus.

















ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS¹

Symbol	Rating	Conditions	Min.	Max.	Units
V _{CC}	Supply voltage		-0.3	6	V
VI	Input voltage		-0.3	V _{CC} + 0.3	V
TJ	Operating junction temperature			125	°C

Notes: 1. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other condition above those indicated in the operation section of this specification is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods may affect device reliability.

Recommended Connections:

- Power and ground connections must be made to multiple V_{CC} and V_{SS} pins. Every MB86930 based circuit board should include power (V_{CC}) and ground (V_{SS}) planes for power distribution. Every V_{CC} pin must be connected to the power plane, and every V_{SS} pin must be connected to the ground plane. Pins identified as "N.C." must not be connected in the system.
- 2. Liberal decoupling capacitance should be placed near the MB86930. The processor can cause transient power surges when its numerous output buffers transition, particularly when connected to large capacitive loads.
- 3. Low inductance capacitors and interconnections are recommended for best high frequency electrical performance. Inductance can be reduced by shortening the board traces between the processor and decoupling capacitors as much as possible. Capacitors specifically designed for PGA and QFP packages will offer the lowest possible inductance.
- 4. For reliable operation, alternate bus masters must drive any pins that are three–stated by the MB86930 when it has granted the bus, in particular –LOCK, ADR < 31:2 >, ASI < 7:0 >, –BE0–3, D < 31:0 >, –AS, and RD/–WR must be driven by alternate bus masters. These pins are normally driven by the processor during active and idle bus states and don't require external pullups. N.C. pins must always remain unconnected.

PACKAGE THERMAL CHARACTERISTICS

Symbol	Parameter	Package		Units		
ØJC	Thermal resistance junction to case	208 Plastic QFP 208 Ceramic QFP 208 Ceramic QFP w/ Heat Sink 179 Ceramic PGA	5.0 1.8 1.6 8.0		°C/W	
			0 m/s	1 m/s	3 m/s	
Ø _{JA}	Thermal resistance junction to ambient	208 Plastic QFP 208 Ceramic QFP 208 Ceramic QFP w/ Heat Sink 179 Ceramic PGA	25 19 16 25	22 15 12 19	19 13 8 13	°C/W

Note: All numbers for package thermal characteristics assume multilayer PCB, except for the numbers for PGA package, which assume a single layer PCB.



DC SPECIFICATIONS 3 V_{CC} = 5V \pm 5%

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{IL}	Input low voltage		0	-	0.8	V
VIH	Input high voltage (All pins except XTAL1)		2.0	-	V _{CC}	V
	Input high voltage (Pin XTAL1)		2.8	-	V _{CC}	V
V _{OL}	Output low voltage	$I_{OL} = 3.2 \text{mA}$	0	-	0.45	V
V _{OH}	Output high voltage	I _{OH} = -0.4mA	2.4	-	V _{CC}	V
ILI	Input leakage current	$V_{IN} = 0 \text{ or } V_{CC}$	-10	-	10	μΑ
I _{LZ}	3-state output leakage current	$V_{OUT} = 0 \text{ or } V_{CC}$	-10	-	10	μΑ
I _{CC}	Operating power supply current. Use Icc (typ) to calculate maximum case and	20 MHz	-	330	440	mA
	ambient temperature allowed. Ambient temperature of die is 125°C.	30 MHz	-	410	470	mA
	For example, allowed ambient temperature = $125^{\circ}C(I_{CC}) \bullet (5.25V) \bullet \emptyset_{JA}$	40 MHz	-	460	570	mA
C _{PIN}	Pin capacitance (All pins except XTAL2)	$V_{CC} = V_I = 0$	-	_	13	pF
	Pin capacitance (Pin XTAL2)	f = 1 MHz	-	-	16	pF

AC CHARACTERISTICS 1,2,4 V_CC = 5V \pm 5%, T_A 0–70 $^{\circ}$ C

Cumhal	Parameter Description		20 MHz		30 MHz		40 MHz		Unite
Symbol			Min.	Max.	Min.	Max.	Min.	Max.	Units
t1	CLKIN period		50	100	33	100	25	100	ns
t2	CLKIN high Time		10		8		6		ns
t3	CLKIN low time		14		12		10		ns
t4	CLKIN rise time			4		3		2	ns
t5	CLKIN fall time			4		3		2	ns
t6	CLKIN to CLKOUT	delay ⁷	0	8	0	8	0	7	ns
t7	CLKIN to CLKOUT	2 delay ⁷	25	33	17	25	13	20	ns
t8	CLKOUT1, CLKOU	IT2 high time ⁷	0.35xPeriod		0.3xPeriod		0.25xPeriod		ns
t9	CLKOUT1, CLKOUT2 low time ⁷		0.4xPeriod		0.4xPeriod		0.4xPeriod		ns
t10	CLKOUT1, CLKOUT2 fall time ⁷			3		3		3	ns
t11	CLKOUT1, CLKOUT2 rise time ⁷			4		4		3	ns
t12	D < 31:0>	Output valid delay		21		19		16	ne
		Output hold	2		2		2		115
	ADR < 31:2>	Output valid delay		24		23		20	ne
		Output hold	2		2		2		113
	-BE0-3	Output valid delay		19		18		16	ns
		Output hold	2		2		2		113
	ASI < 7:0>	Output valid delay		22		20		17	ns
		Output hold	2		2		2		113
t13	-CS	Output valid delay		24		23		20	ne
		Output hold	2		2		2		113
t14	-SAME_PAGE	Output valid delay		23		22		20	ns
		Output hold	2		2		2		115



	Parameter Description		20 MHz		30 MHz		40 MHz		
Symbol			Min.	Max.	Min.	Max.	Min.	Max.	Units
t15	RD/WR	Output valid delay		18		17		15	
		Output hold	2		2		2		ns
t16	-LOCK	Output valid delay		19		18		16	
		Output hold	2		2		2		ns
t17	–AS	Output valid delay		21		20		18	
		Output hold	2		2		2		ns
t18	-TIMER_OVF	Output valid delay		20		19		18	ns
		Output hold	2		2		2		
t19	-BGRNT	Output valid delay		20		18		15	
		Output hold	2		2		2		115
t20	-MEXC input setup time		14		12		12		ns
t21	-READY input se	tup time	15		14		12		ns
t22	D < 31:0> input se	etup time	11		10		9		ns
t23	-BREQ input setu	ıp time	8		7		6		ns
t24	IRL < 3:0> input s	etup time ⁶	6		6		6		ns
t25	-MEXC input hold time		2		2		1		ns
t26	-READY input hold time		2		2		1		ns
t27	D < 31:0> input hold time		3		3		2		ns
t28	-BREQ input hold	l time	3		3		2		ns
t29	IRL < 3:0> input h	old time ⁶	5		5		5		ns

AC CHARACTERISTICS 1,2,4 V_CC = 5V \pm 5%, T_A 0–70 $^{\circ}\text{C}$ (Continued)

1. Parameters are valid over specified temperature range and supply voltage range unless otherwise noted.

 All voltage measurements are referenced to ground. All time measurements are referenced at input and output levels of 1.5V. For testing, all inputs swing between 0.4V and 2.4V (Except XTAL1 which swings from 0.4V to 3.0V). Input rise and fall times are 2ns or less.

3. Not more than one output may be shorted at a time for a maximum duration of one second.

4. Timing specifications apply to frequency of operation listed at top of column.

5. All output timings are based on a 50pF load.

6. The IRL input setup and hold times are measured with respect to the midpoint of the input clock cycle.

7. These specs will be improved in the future.

8. Data bus output driver control is same as for RD/–WR so timing is similar.





















Ordering Information: MB86930-20PF-G











Ordering Information: MB86930-40CR-G

